32-Channel LCD Driver with Separate Backplane Output

Features

- HVCMOS[®] technology
- 32 push-pull CMOS output up to 60V
- Low power level shifting
- ▶ Shift register speed 5.0MHz
- Latched data outputs
- Bidirectional shift register (DIR)
- Backplane output

General Description

The HV66 is a low voltage serial to high voltage parallel converter with push-pull outputs. This device has been designed for use as a driver circuit for LCD displays. It can also be used in any application requiring multiple output high voltage current sourcing and sinking capabilities. The inputs are fully CMOS compatible.

The device consists of a 32-bit shift register, 32 latches, and control logic to perform blanking and polarity control of the outputs. HV_{OUT} 1 is connected to the first stage of the shift register. Data is shifted through the shift register on the logic rising transition of the clock. A DIR pin causes data shifting clockwise when grounded and counter clockwise when connected to VDD. A data output buffer is provided for cascading devices. This output reflects the current status of the last bit of the shift register. Operation of the shift register is not affected by the LE (latch enable), \overline{BL} (blank) or the POL (polarity) inputs. Transfer of data from the shift register to the latch occurs when the LE (latch enable) input is high. The data in the latch is stored after LE transitions from high to low.

Functional Block Diagram



Ordering Information

Part Number	Package Option	Packing
HV66PG-G	44-Lead PQFP	96/Tray
HV66PG-G M919	44-Lead PQFP	500/Reel
HV66PJ-G	44-Lead PLCC	27/Tube
HV66PJ-G M903	44-Lead PLCC	500/Reel

-G denotes a lead (Pb)-free / RoHS compliant package

Absolute Maximum Ratings¹

Parameter	Value
Supply voltage, V _{DD} ²	-0.5V to +7.0V
Supply voltage, V _{PP} ²	-0.5V to +70V
Logic input levels	-0.5V to V_{DD} +0.5V
Ground current ³	1.5A
Continuous total power dissipation ⁴	1200mW
Operating temperature range	-40°C to +85°C
Storage temperature range	-65°C to +125°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to GND.

Notes:

- 1. Device will survive (but operation may not be specified or guaranteed) at these extremes
- 2. All voltages are referenced to GND
- 3. Duty cycle is limited by the total power dissipated in the package
- 4. For operation above 25°C ambient derate linearly to 85°C at 20mW/°C

Typical Thermal Resistance

Package	$\boldsymbol{\theta}_{_{ja}}$	
44-Lead PQFP	51°C/W	
44-Lead PLCC	37°C/W	

Pin Configuration



Product Marking



Package may or may not include the following marks: Si or

44-Lead PQFP



Package may or may not include the following marks: Si or 🎲

44-Lead PLCC

Recommended Operating Conditions

Sym	Parameter	Min	Max	Units
V _{DD}	Logic supply voltage	4.5	5.5	V
V _{PP}	High voltage supply	12	60	V
V _{IH}	High-level input voltage	2.4	V _{DD}	V
V _{IL}	Low-level input voltage	0	0.8	V
f _{ськ}	Clock frequency	0	5.0	MHz
T _A	Operating free-air temperature	-40	+85	°C
I _{OD}	Allowable current through output diodes	-	200	mA

Electrical Characteristics (over recommended operating conditions unless otherwise noted)

DC Characteristics $(V_{DD} = 5.0V, V_{PP} = 60V)$

Sym	Parameter		Min	Max	Units	Conditions
I _{DD}	V _{DD} supply current		-	15	mA	V _{DD} = 5.5V, f _{CLK} = 5.0MHz
1		ront	-	0.5	mA	Outputs high
PPQ	Quiescent v _{PP} supply cun	Quiescent V_{PP} supply current			mA	Outputs low
I _{DDQ}	Quiescent V _{DD} supply cur	rent	-	0.5	mA	All V_{IN} = GND or V_{DD}
V	High-level output	HV _{out}	50	-	V	I ₀ = -5.0mA, V _{PP} = +60V
V _{OH}		DATA OUT	4.6	-	v	Ι _o =-100μΑ
V	Low-level output	HV _{out}	-	8.0	v	I ₀ = +5.0mA, V _{PP} = +60V
V _{ol}		DATA OUT	-	0.4	V	Ι _o = +100μΑ
I _{IH}	High-level input current		-	1.0	μA	V _{IH} = V _{DD}
I _{IL}	Low-level input current		-	-1.0	μA	V _{IL} = 0V
V_{OLBP}	Low-level output voltage,	backplane	-	3.0	V	I _o =+10mA
V_{OHBP}	High-level output voltage,	backplane	57	-	V	I _o = -10mA

AC Characteristics (V_{DD} = 5.0V, V_{PP} = 60V, T_A = 25°C, logic input rise/fall time = 10ns.)

f _{clk}	Clock frequency	-	5.0	MHz	
t _{wL,} t _{wH}	Clock width high or low	100	-	ns	
t _{su}	Data set-up time before clock rises	25	-	ns	
t _H	Data hold time after clock rises	50	-	ns	
t _{HON} , t _{HOFF}	Time from latch enable or POL to HV_{OUT}	-	500	ns	C _L = 20pF
t_{BON}, t_{BOFF}	Time from POL to BP _{OUT}	-	500	ns	C _L = 20pF
t _{DHL}	Delay time clock to data high to low	-	200	ns	C _L = 10pF
t _{DLH}	Delay time clock to data low to high	-	200	ns	C _L = 10pF
t _{DLE}	Delay time clock to LE low to high	50	-	ns	
t _{wLE}	Width of LE pulse	100	-	ns	
t _{sle}	LE set-up time before clock rises	50	-	ns	
t _{BR} , t _{BF}	BP _{out} rise/fall time	10	1000	μs	C _L = 350pF
t _{BR} - t _{BF}	BP _{out} rise and fall difference	-	100	μs	C _L = 350pF

Power-up sequence should be the following:

- 1. Connect ground.
- Apply V_{DD}.
 Set all inputs (Data, CLK, EN, etc.) to a known state.
- 4. Apply V_{PP} .

The V_{PP} should not drop below V_{DD} during operation.

Power-down sequence should be the reverse of the above.

Function Table

			Inp	uts			Outputs				
Function	Data	CLK	LE	BL	POL	DIR	Shift Reg 1, 2, 32	ΗV _{ουτ} 1, 2, 32	Data Out	BP _{out}	
Load S/R,	L or H	1	L	Ignore	Ignore	Н	$Data \to Q_{1^{\dots}} \to Q_{32}$	Ignore	Q ₃₂	Ignore	
R/L Shift	L or H	1	L	Ignore	Ignore	L	$Q_1 \leftarrowQ_{32} \leftarrow Data$	Ignore	Q ₁	Ignore	
Load Latches	х	H or L	Н	Н	Н	Х	**	/**	No Change	Н	
Load Lateries	Х	H or L	Н	н	L	Х	**	**	No Change	L	
	L or H	1	н	н	н	н	$Data \to Q_{1} \to Q_{32}$	/**	Q ₃₂	Н	
Transparent	L or H	1	Н	н	L	Н	$Data \to Q_{_1} \!\! \to Q_{_{32}}$	**	Q ₃₂	L	
Mode	L or H	1	Н	н	н	L	$Q_1 \leftarrowQ_{32} \leftarrow Data$	/**	Q ₁	Н	
	L or H	1	Н	н	L	L	$Q_1 \leftarrowQ_{32} \leftarrow Data$	**	Q ₁	L	
Blank	Х	х	Х	L	L	Х	Х	LL	Ignore	L	
Control	Х	Х	Х	L	Н	Х	Х	НН	Ignore	Н	

Notes:

*

L - Low level

X - Don't care

Ignore - The state of the specific input or output is irrelevant to demonstrate the occurred event

↑ - Low to High transition

- Dependent on previous stage's state before the last CLK or last LE high

Switching Waveforms



HV66

44-Lead PQFP Pin Description

Pin #	Function	Pin #	Function	Pin
1	HV _{out} 11	16	HV _{out} 26	31
2	HV _{out} 12	17	HV _{out} 27	32
3	HV _{out} 13	18	HV _{out} 28	33
4	HV _{out} 14	19	HV _{out} 29	34
5	HV _{out} 15	20	HV _{out} 30	35
6	HV _{out} 16	21	HV _{out} 31	36
7	HV _{out} 17	22	HV _{OUT} 32	37
8	HV _{out} 18	23	DATA OUT	38
9	HV _{out} 19	24	GND	39
10	HV _{out} 20	25	N/C	40
11	HV _{out} 21	26	BL	41
12	HV _{out} 22	27	POL	42
13	HV _{out} 23	28	LE	43
14	HV _{OUT} 24	29	VDD	44
15	HV _{OUT} 25	30	CLK	

Pin #	Function
31	DIR
32	DATA IN
33	VPP
34	BP _{OUT}
35	HV _{out} 1
36	HV _{out} 2
37	HV _{OUT} 3
38	HV _{out} 4
39	HV _{out} 5
40	HV _{out} 6
41	HV _{out} 7
42	HV _{out} 8
43	HV _{out} 9
44	HV _{out} 10

 Function

 HV_{out}^2
 HV_{out}^3
 HV_{out}^7
 HV_{out}^7

44-Lead PLCC Pin Description

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Pin	Function	Pin	Function	Pin
1	HV _{out} 16	16	HV _{out} 31	31
2	HV _{out} 17	17	HV _{out} 32	32
3	HV _{out} 18	18	DATA OUT	33
4	HV _{out} 19	19	GND	34
5	HV _{out} 20	20	N/C	35
6	HV _{out} 21	21	BL	36
7	HV _{out} 22	22	POL	37
8	HV _{out} 23	23	LE	38
9	HV _{out} 24	24	VDD	39
10	HV _{out} 25	25	CLK	40
11	HV _{out} 26	26	DIR	41
12	HV _{out} 27	27	DATA IN	42
13	HV _{out} 28	28	VPP	43
14	HV _{out} 29	29	BP _{out}	44
15	HV _{out} 30	30	HV _{out} 1	

44-Lead PQFP Package Outline (PG) 10.00x10.00mm body, 2.35mm height (max), 0.80mm pitch



Note:

1. A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.

Symbo	ol	Α	A1	A2	b	D	D1	Е	E1	е	L	L1	L2	θ
	MIN	1.95*	0.00	1.95	0.30	13.65*	9.80*	13.65*	9.80*		0.73			0 0
Dimension (mm)	NOM	-	-	2.00	-	13.90	10.00	13.90	10.00	0.80 BSC	0.88	1.95 REF	0.25 BSC	3.5 ⁰
	MAX	2.35	0.25	2.10	0.45	14.15*	10.20*	14.15*	10.20*	200	1.03		200	7 °

JEDEC Registration MO-112, Variation AA-2, Issue B, Sep. 1995.

* This dimension is not specified in the JEDEC drawing.

Drawings not to scale.

Supertex Doc. #: DSPD-44PQFPPG, Version C041309.

44-Lead PLCC Package Outline (PJ) .653x.653in body, .180in height (max), .050in pitch



Notes:

1. A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.

2. Actual shape of this feature may vary.

Symbol		Α	A1	A2	b	b1	D	D1	E	E1	е	R
Dimension (inches)	MIN	.165	.090	.062	.013	.026	.685	.650	.685	.650	.050 BSC	.025
	NOM	.172	.105	-	-	-	.690	.653	.690	.653		.035
	MAX	.180	.120	.083	.021	.036†	.695	.656	.695	.656		.045

JEDEC Registration MS-018, Variation AC, Issue A, June, 1993.

† This dimension differs from the JEDEC drawing.

Drawings not to scale.

Supertex Doc. #: DSPD-44PLCCPJ, Version F031111.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <u>http://www.supertex.com/packaging.html</u>.)

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